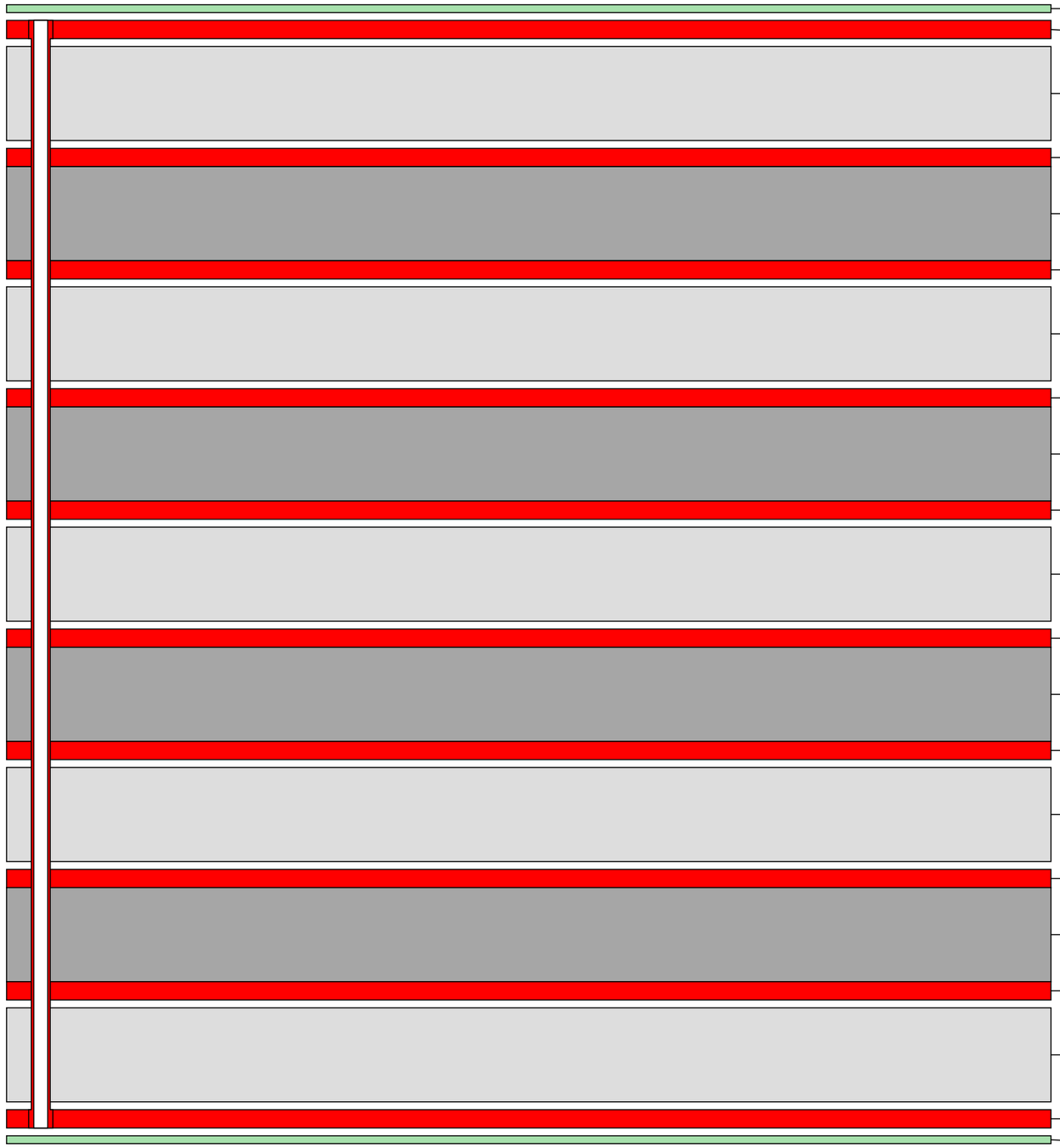

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		0.220mm	Prepreg IPC-4101/127/128	4,3	0,011	FR-4.1 filled, halogen free
2	Inner Layer 1	0.035mm	ED Base Copper			
		0.200mm	Core IPC-4101/127/128	4,4	0,011	FR-4.1 filled, halogen free
3	Inner Layer 2	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/127/128	4,3	0,011	FR-4.1 filled, halogen free
4	Inner Layer 3	0.035mm	ED Base Copper			
		0.200mm	Core IPC-4101/127/128	4,4	0,011	FR-4.1 filled, halogen free
5	Inner Layer 4	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/127/128	4,3	0,011	FR-4.1 filled, halogen free
6	Inner Layer 5	0.035mm	ED Base Copper			
		0.200mm	Core IPC-4101/127/128	4,4	0,011	FR-4.1 filled, halogen free
7	Inner Layer 6	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/127/128	4,3	0,011	FR-4.1 filled, halogen free
8	Inner Layer 7	0.035mm	ED Base Copper			
		0.200mm	Core IPC-4101/127/128	4,4	0,011	FR-4.1 filled, halogen free
9	Inner Layer 8	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/127/128	4,3	0,011	FR-4.1 filled, halogen free
10	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts

Total thickness: 2.280mm

BASIC10_ML10_2,28_35_V2.12

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:
► **www.we-online.com**

PCB Thickness Tolerance: ± 10%

customer		**created**	
pcb name		**approved**	
engineer		**format**	**A4, landscape**
date			

Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen

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